General Purpose ESD Protection - SP05 Series

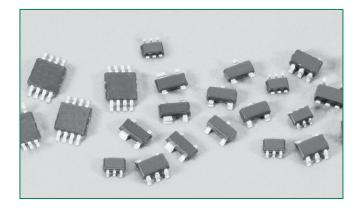
## SP05 Series - 30pF 30kV Unidirectional TVS Array



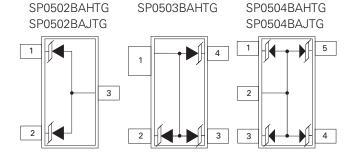


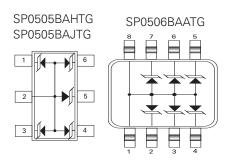






#### **Pinout**





#### **Description**

This surface mount family of arrays suppress ESD and other transient overvoltage events. Used to meet the International Electrotechnical Compatibility (IEC transient immunity standards IEC 61000-4-2 for Electrostatic Discharge Requirements), these components can help protect sensitive digital or analog input circuits on data, signal, or control lines with voltage levels up to 5VDC.

The monolithic silicon arrays are comprised of specially designed structures for transient voltage suppression (TVS). The size and shape of these structures have be tailored for transient protection. Compared to MOVs, this diode array provides a lower clamping voltage and lower off-state capacitance.

#### **Features**

- An Array of 2, 3, 4, 5 or 6 TVS Avalanche Diodes in a ultra small SC70, SOT-23, SOT-143 or MSOP packages
- ESD Capability Standards
  - IEC 61000-4-2, Direct Discharge ....... 30kV (Level 4)
  - IEC 61000-4-2, Air Discharge............. 30kV (Level 4)
  - MIL STD 883 3015.7.....30kV
- Input Protection for Applications Up to 5VDC
- Fast Response Time .....<1ns
- Low Input Capacitance......30pF Typical
- Operating Temperature Range.....-40°C to 125°C
- AEC-Q101 Qualified

#### **Applications**

- Mobile phone handsets
- Personal Digital Assistants (PDA)
- Portable handheld equipment (Laptop, Palmtop computers)
- · Computer port, keyboard (USB1.1)
- Digital still cameras
- Digital video cameras
- MP3 players
- Moisture Sensitivity Level (MSL-1)

#### **Additional Information**







Resources



Samples

Life Support Note:

Not Intended for Use in Life Support or Life Saving Applications

The products shown herein are not designed for use in life sustaining or life saving applications unless otherwise expressly indicated

# **TVS Diode Array**

### **Absolute Maximum Ratings**

Symbol	Symbol Parameter		Units
T <sub>OP</sub>	Operating Temperature	-40 to 125	°C
T <sub>STOR</sub>	Storage Temperature	-55 to 150	°C

Notes

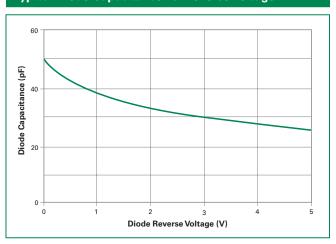
CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the component. This is a stress only rating and operation of the component at these or any other conditions above those indicated in the operational sections of this specification is not implied.

### Electrical Characteristics T<sub>A</sub> = +25°C, Unless Otherwise Specified

Parameter	Test Conditions	Min	Тур	Max	Units
Reverse Standoff Voltage	I <sub>R</sub> ≤ 1μA	-	-	5.5	V
Reverse Standoff Leakage Current	V = 5.0V		1	100	nA
Signal Clamp Voltage					
Positive	I = 1mA	6.0		8.5	V
Negative	I = 10mA	-1.2	-0.8	-0.4	V
Clamp Voltage during ESD					
MIL-STD-883 Method 3015 (HBM) test					
+ 8kV			12		V
- 8kV			-8		V
ESD Test Level (1)					
IEC-61000-4-2, Contact discharge		30			kV
MIL-STD-883 Method 3015 (HBM)		30			kV
Capacitance	2.5V @ 1MHz		30		pF
Turn on/off Time			<1		ns
Diode Dynamic Resistance					
Forward Conduction			1.0		Ω
Reverse Conduction			1.4		Ω

Note

### Typical Diode Capacitance vs. Reverse Voltage

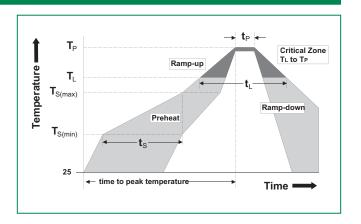


<sup>(1)</sup> ESD voltage applied between channel pins and ground, one pin at a time; all other channel pins are open; all ground pins are grounded.

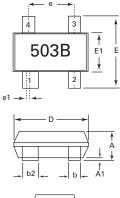


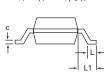
### **Soldering Parameters**

Reflow Co	ndition	Pb – Free assembly	
	-Temperature Min (T <sub>s(min)</sub> )	150°C	
Pre Heat	-Temperature Max (T <sub>s(max)</sub> )	200°C	
	-Time (min to max) (t <sub>s</sub> )	60 – 180 secs	
Average ramp up rate (Liquidus) Temp (T,) to peak		5°C/second max	
T <sub>S(max)</sub> to T <sub>L</sub>	- Ramp-up Rate	5°C/second max	
Reflow	-Temperature (T <sub>L</sub> ) (Liquidus)	217°C	
nellow	-Temperature (t <sub>L</sub> )	60 – 150 seconds	
PeakTemp	erature (T <sub>P</sub> )	260 <sup>+0/-5</sup> °C	
Time within 5°C of actual peak Temperature (t <sub>o</sub> )		20 - 40 seconds	
Ramp-down Rate		5°C/second max	
Time 25°C to peak Temperature (T <sub>P</sub> )		8 minutes Max.	
Do not exc	ceed	260°C	



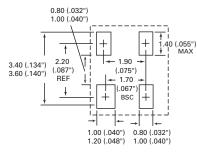
### Package Dimensions — SOT143





### SP0503BAHTG - SOT143-4

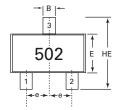
Recommended Pad Layout



Package	SOT143-4			
Pins	4			
JEDEC		TO-	253	
	Millin	neters	Inc	hes
	Min	Max	Min	Max
Α	0.8	1.22	0.03	0.048
A1	0.05	0.15	0.002	0.006
b	0.30	0.50	0.012	0.020
b2	0.76	0.89	0.030	0.035
С	0.08	0.20	0.003	0.008
D	2.80	3.04	0.110	0.120
E	2.10	2.64	0.082	0.104
E1	1.20	1.40	0.047	0.055
е	1.92 BSC 0.076 BSC			BSC
e1	0.20 BSC		0.008 BSC	
L	0.4	0.6	0.016	0.024
L1	0.550	REF	0.022	REF

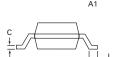


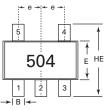
## Package Dimensions — SC70



SP0502BAJTG - SC70-3

Package	SC70-3				
Pins	3				
JEDEC		MO	-203		
	Millin	neters	Inc	hes	
	Min	Max	Min	Max	
Α	0.80	1.10	0.031	0.043	
A1	0.00	0.10	0.00	0.004	
A2	0.70	1.00	0.028	0.039	
В	0.15	0.30	0.006	0.012	
С	0.08	0.25	0.003	0.010	
D	1.85	2.25	0.073	0.089	
E	1.15	1.35	0.045	0.053	
е	0.66 BSC 0.026 BSC			BSC	
HE	2.00	2.40	0.079	0.094	
L	0.26	0.46	0.010	0.018	



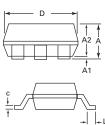


SP0504BAJTG - SC70-5

N (REF)

M (REF)

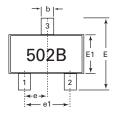
Package		SC	70-5	
Pins		!	5	
JEDEC		MO	-203	
	Millin	neters	Inc	hes
	Min	Max	Min	Max
Α	0.80	1.10	0.031	0.043
A1	0.00	0.10	0.00	0.004
A2	0.70	1.00	0.028	0.039
В	0.15	0.30	0.006	0.012
С	0.08	0.25	0.003	0.010
D	1.85	2.25	0.073	0.089
E	1.15	1.35	0.045	0.053
е	0.65 BSC 0.026 BSC			
HE	2.00	2.40	0.079	0.094
L	0.26	0.46	0.010	0.018

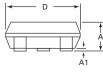


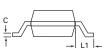
e - e - e - 6 6 5 4	SP0505BAJTG - SC70-6
505 F HE	Recommended Pad Layout
→ B ← D →	+ 1 - 1 - 1 - 1
A2 Å	T P

Package	SC70-6				
Pins	6				
JEDEC		МО	-203		
	Millin	neters	Inc	hes	
	Min	Max	Min	Max	
Α	0.80	1.10	0.031	0.043	
A1	0.00	0.10	0.00	0.004	
A2	0.70	1.00	0.028	0.039	
В	0.15	0.30	0.006	0.012	
С	0.08	0.25	0.003	0.010	
D	1.85	2.25	0.073	0.089	
E	1.15	1.35	0.045	0.053	
е	0.65	BSC	0.026 BSC		
HE	2.00	2.40	0.079	0.094	
L	0.26	0.46	0.010	0.018	
M	-	1.60	-	0.063	
N	-	1.30	-	0.051	
0	-	0.65	-	0.026	
Р	-	0.70	-	0.028	
R	-	0.35	-	0.014	
S	-	0.90	-	0.035	
T	-	2.50	-	0.098	

### Package Dimensions — SOT23

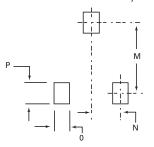




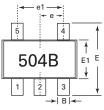


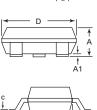
### SP0502BAHTG - SOT23-3

Recommended Pad Layout



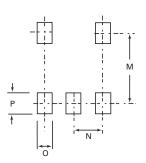
Package	SOT23-3				
Pins	3				
JEDEC		TO-	236		
	Millin	neters	Inc	hes	
	Min	Max	Min	Max	
Α	0.89	1.12	0.035	0.044	
A1	0.01	0.1	0.0004	0.004	
b	0.3	0.5	0.012	0.020	
С	0.08	0.2	0.003	0.008	
D	2.8	3.04	0.110	0.120	
E	2.1	2.64	0.083	0.104	
E1	1.2	1.4	0.047	0.055	
е	0.95 BSC		0.038	BSC	
e1	1.90 BSC		0.075	BSC	
L1	0.54	REF	0.021	I REF	
M		2.29		.090	
N		0.95		0.038	
0		0.78		.030TYP	
P		0.78		.030TYP	



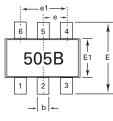


### SP0504BAHTG - SOT23-5

Recommended Pad Layout



Package	SOT23-5					
Pins	5					
JEDEC	MO-178					
	Millin	neters	Inc	hes		
	Min	Max	Min	Max		
Α	-	1.45	-	0.057		
A1	0	0.15	0	0.006		
b	0.3	0.5	0.012	0.020		
С	0.08	0.22	0.003	0.009		
D	2.75	3.05	0.108	0.120		
E	2.6	3.0	0.102	0.118		
E1	1.45	1.75	0.057	0.069		
е	0.95	BSC	0.038	BSC		
e1	1.90	BSC	0.075	BSC		
L1	0.60 REF		0.024	1 REF		
M		2.59		.102		
N		0.95		.038		
0		0.69		.027TYP		
Р		n 99		USOLAb		

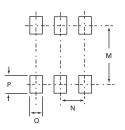






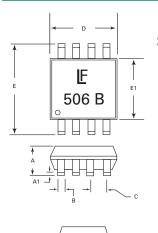
### SP0505BAHTG - SOT23-6

Recommended Pad Layout



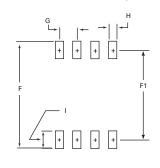
		0.00		.000111	
Package	SOT23-6				
Pins	6				
JEDEC		МО	-178		
	Millin	neters	Inc	hes	
	Min	Max	Min	Max	
Α	-	1.45	-	0.057	
A1	0	0.15	0	0.006	
b	0.3	0.5	0.012	0.020	
С	0.08	0.22	0.003	0.009	
D	2.75	3.05	0.108	0.120	
E	2.6	3.0	0.102	0.118	
E1	1.45	1.75	0.057	0.069	
е	0.95	BSC	0.038	BSC	
e1	1.90 BSC		0.075	BSC	
L1	0.60	REF	0.024	∤ REF	
M		2.59		.102	
N		0.95		0.038	
0		0.69		.027TYP	
Р		0.99		.039TYP	

#### Package Dimensions — MSOP



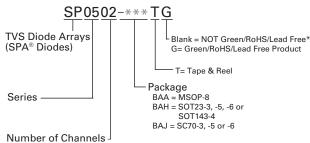
### SP0506BAATG - MSOP-8

Recommended Pad Layout



Package	MSOP				
Pins	8				
JEDEC		MO	-187		
	Millin	neters	Inc	hes	
	Min	Max	Min	Max	
D	2.90	3.10	0.114	.122	
E	4.78	4.98	.188	.196	
E1	2.90	3.10	.114	.122	
Α	0.87	1.17	.034	.046	
A1	0.05	0.25	.002	0.010	
В	-	0.30TYP	-	0.012TYP	
С	-	0.65TYP	-	0.026TYP	
L1	0.52	0.54	0.020	0.021	
L2	-	0.18TYP	-	.007TYP	
F	-	5.28	-	.208	
F1	-	4.24	-	.167	
G	-	0.65	-	0.026	
Н	-	0.38	-	.015	
I	-	1.04	-	.041	

### **Part Numbering System**



02 = 2 channel (SC70-3, SOT23 packages)

03 = 3 channel (SOT143 package) 04 = 4 channel (SC70-5, SOT23-5 package) 05 = 5 channel (SC70-6, SOT23-6 packages)

06 = 6 channel (MSOP-8 package)

#### **Ordering Information**

\*NOTE: To order NON-Green/RoHS/Lead Free version of product, remove "G" at the end of part number.

Part Number	СН	Package Type	Quantity Per Reel
SP0502BAHTG	2	SOT23-3	3000
SP0503BAHTG	3	SOT143-4	3000
SP0504BAHTG	4	SOT23-5	3000
SP0505BAHTG	5	SOT23-6	3000
SP0506BAATG	6	MSOP-8	4000
SP0502BAJTG	2	SC70-3	3000
SP0504BAJTG	4	SC70-5	3000
SP0505BAJTG	5	SC70-6	3000

### **Product Characteristics**

Lead Plating	"G" Green version - Matte Tin (Sn)
Lead Material	Copper / Iron Alloy
Lead Coplanarity	0.004 inches (0.102mm)
Substrate Material	Silicon
Body Material	Molded Compound
Flammability	UL Recognized compound meeting flammability rating V-0

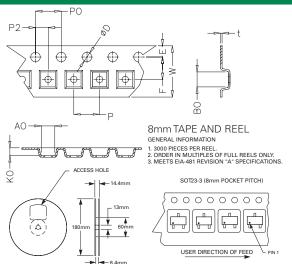
#### Notes:

- 1. All dimensions are in millimeters.
- 2. Dimensions include solder plating.
- 3. Dimensions are exclusive of mold flash & metal burr.
- 4. Blo is facing up for mold and facing down for trim/form, i.e. reverse trim/form.
- Package surface matte finish VDI 11-13



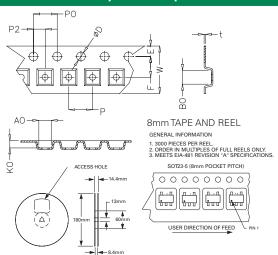
# General Purpose ESD Protection - SP05 Series

### Embossed Carrier Tape & Reel Specification — SOT23-3



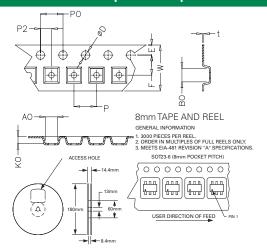
Cumphal	Millin	netres	Inches	
Symbol	Min	Max	Min	Max
E	1.65	1.85	0.065	0.073
F	3.40	3.60	0.134	0.142
P2	1.90	2.10	0.075	0.083
D	1.40	1.60	0.055	0.063
P0	3.90	4.10	0.154	0.161
W	7.70	8.30	0.303	0.327
Р	3.90	4.10	0.154	0.161
A0	3.05	3.25	0.120	0.128
В0	2.67	2.87	0.105	0.113
K0	1.12	1.32	0.044	0.052
t	0.22	0.24	0.009	0.009

### Embossed Carrier Tape & Reel Specification — SOT23-5



Cumphal	Millimetres		Inches	
Symbol	Min	Max	Min	Max
E	1.65	1.85	0.065	0.073
F	3.40	3.60	0.134	0.142
P2	1.90	2.10	0.075	0.083
D	1.40	1.60	0.055	0.063
P0	3.90	4.10	0.154	0.161
W	7.70	8.30	0.303	0.327
Р	3.90	4.10	0.154	0.161
A0	3.05	3.25	0.120	0.128
В0	2.67	2.87	0.105	0.113
K0	1.12	1.32	0.044	0.052
t	0.22	0.24	0.009	0.009

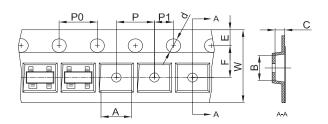
### Embossed Carrier Tape & Reel Specification — SOT23-6

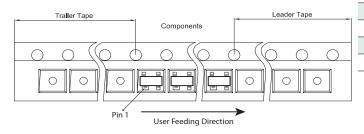


Cymbol	Millin	netres	Inches	
Symbol	Min	Max	Min	Max
E	1.65	1.85	0.065	0.073
F	3.40	3.60	0.134	0.142
P2	1.90	2.10	0.075	0.083
D	1.40	1.60	0.055	0.063
P0	3.90	4.10	0.154	0.161
W	7.70	8.30	0.303	0.327
Р	3.90	4.10	0.154	0.161
Α0	3.05	3.25	0.120	0.128
В0	2.67	2.87	0.105	0.113
K0	1.12	1.32	0.044	0.052
t	0.22	0.24	0.009	0.009



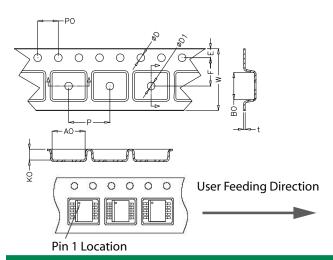
### Embossed Carrier Tape & Reel Specification — SOT143-4





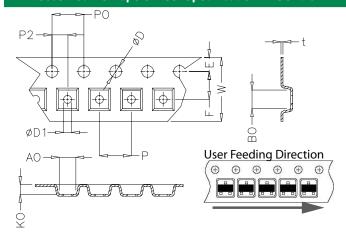
Symbol	Millimetres		Inches	
	Min	Max	Min	Max
Α	3.09	3.09	0.122	0.130
В	2.70	2.90	1.106	0.114
С	1.21	1.41	0.048	0.056
d	1.40	1.60	0.055	0.102
Е	1.65	0.85	0.065	0.073
F	3.45	3.65	0.133	0.142
P0	4.10	3.90	0.154	0.161
Р	4.10	3.90	0.154	0.161
P1	1.90	2.10	0.075	0.083
W	7.90	8.10	0.311	0.319

### Embossed Carrier Tape & Reel Specification — MSOP-8



	Millimetres		Incl	nes
	Min	Max	Min	Max
E	1.65	1.85	0.065	0.073
F	5.40	5.60	0.213	0.220
D	1.50	1.60	0.059	0.063
D1	1.50	Min	0.059 Min	
P0	3.90	4.10	0.154	0.161
W	11.70	12.30	0.461	0.484
Р	7.90	8.10	0.311	0.319
A0	5.20	5.40	0.205	0.213
В0	3.30	3.40	0.126	0.134
K0	1.20	1.40	0.047	0.055
t	0.30 ± 0.05		0.012±	0.002

### Embossed Carrier Tape & Reel Specification — SC70-3

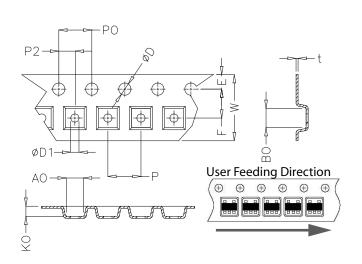


Symbol	Millim	netres	Inc	hes
	Min	Max	Min	Max
Е	1.65	1.85	0.064	0.073
F	3.45	3.55	0.135	0.139
P2	1.95	2.05	0.077	0.081
D	1.40	1.60	0.055	0.063
D1	1.00	1.25	0.039	0.049
P0	3.90	4.10	0.154	0.161
W	7.70	8.10	0.303	0.318
Р	3.90	4.10	0.153	0.161
A0	2.14	2.34	0.084	0.092
В0	2.24	2.44	0.088	0.096
K0	1.12	1.32	0.044	0.052
t	0.27	Max	0.010	Max



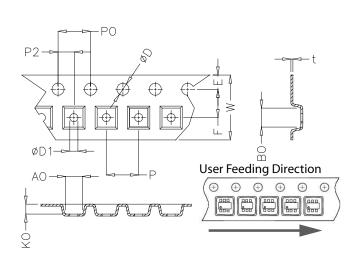
# General Purpose ESD Protection - SP05 Series

### **Embossed Carrier Tape & Reel Specification — SC70-5**



Symbol	Millin	netres	Inches	
	Min	Max	Min	Max
E	1.65	1.85	0.064	0.073
F	3.45	3.55	0.135	0.139
P2	1.95	2.05	0.077	0.081
D	1.40	1.60	0.055	0.063
D1	1.00	1.25	0.039	0.049
P0	3.90	4.10	0.154	0.161
W	7.70	8.10	0.303	0.318
Р	3.90	4.10	0.153	0.161
A0	2.14	2.34	0.084	0.092
В0	2.24	2.44	0.088	0.096
K0	1.12	1.32	0.044	0.052
t	0.27	Max	0.010	Max

### Embossed Carrier Tape & Reel Specification — SC70--6



	Millio	Millimetres Inches		hoo
Symbol	IVIIIIIII	letres	IIIC	iles
7,	Min	Max	Min	Max
E	1.65	1.85	0.064	0.073
F	3.45	3.55	0.135	0.139
P2	1.95	2.05	0.077	0.081
D	1.40	1.60	0.055	0.063
D1	1.00	1.25	0.039	0.049
P0	3.90	4.10	0.154	0.161
W	7.70	8.10	0.303	0.318
Р	3.90	4.10	0.153	0.161
A0	2.14	2.34	0.084	0.092
В0	2.24	2.44	0.088	0.096
КО	1.12	1.32	0.044	0.052
t	0.27 Max		0.010	Max

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